Features

- 40 1500MHz
- Gain 17.2dB @ 900MHz
- CSO 66dBc @ 30dBmV
- CTB 76dBc @ 30dBmV
- NF dB @ 200MHz
- Lead-free / Green / RoHS♥ compliant SOT-89 Package

Applications

- Headend
- Indoor Amplifier
- Drop Amplifier
- Cable Modem
- Laser Diode Driver
- FTTH Receiver
- Optical Transmitter
- RFoG/MOCA

Functional Diagram

RF IN 1 RF OUT / Bias 3 GND 2,4



ESD/MSL

- ESD sensitive device. Observe handling precautions.
- 2 MSL 3, J-STD-020

Description

The PK831 is a high performance p-HEMT MMIC Amplifier that is internally matched to 75Ω input/output. The features of PK831 are excellent gain flatness, broadband, high CSO/CTB performance, high reliability and low noise as a CATV amplifier. The PK831 operates from a single supply voltage and requires minimal external components for operation. The purpose of using PK831 is that offers high dynamic range in a low cost surface - mounted plastic SOT-89 package. All devices are 100% RF and DC tested.

Specifications

Parameter	Units	Тур.	Condition
S21	dB	17.3	40 ~ 1500MHz
S11	dB	-22	@ 900MHz
S22	dB	-18	@ 900MHz
CSO	dBc	66	30dBmV/132ch Flat
CTB	dBc	76	30dBmV/132ch Flat
OIP3	dBm	40	Note 1 ²⁾
P1dB	dBm	21.5	@ 900MHz
NF	dB	2.0	@ 900MHz
V/I	V/mA	5/125	
Rth	°C/W	27	

Test Conditions : T=25°C, Supply Voltage=5V, 75ohm System
Note 1. Two Tones, 1MHz Spacing, 5dBm per Tone at Output

Absolute Maximum Ratings

Parameter	Rating	Unit
Device Voltage	9	V
Device Current	180	mA
RF Power Input	3	dBm
Storage Temperature	-55 to 150	°C
Ambient Operating Temperature	-40 to 85	°C
Junction Temperature	185	°C

1) Stresses above the maximum values listed have may cause permanent damage to the device.

2) MTTF is more than 100 years.



Lead-free /RoHS Compliant / Green SOT-89 Package Outline



DEE	DIMENSIONS (mm)		
	Min.	Max.	
А	1.40	1.60	
В	0.43	0.58	
B1	0.36	0.54	
С	0.35	0.46	
D	4.30	4.70	
D1	1.50	1.87	
Е	2.29	2.70	
E1	2.13	2.18	
е	1.5		
e1	3.0	3.0	
Н	3.43	5.10	
L	0.74	1.20	

Land Pattern



Evaluation Board Layout (40x40)

E1



Mounting Instructions

- 1 Use a large ground pad area with many plated through-holes as shown.
- 2 We recommend 1 oz copper minimum.
- 3 Measurement for our data sheet was made on 1.6mm thick FR-4 Board.
- 4 RF trace width depends on the board material and construction.
- 5 Add mounting screws near the part to fasten the board to a heatsink.
- 6 Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.